



3729

PATENT APPLICATION
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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Bogursky et al.
Application No.: 10/084,125
Filed: 2/28/02

Art Unit: 3729
Examiner:

For: Discrete Solder Ball Contact, etc.
Commissioner Of Patents And Trademarks
Washington, D.C. 20231
Sir:

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RESCISSION OF NON-PUBLICATION REQUEST

Applicants hereby rescind any earlier Non-Publication request under 35 USC 122(b), as a corresponding patent application has been filed in the European Patent Office.

Respectfully submitted,
R. Bogursky et al.

J. Oisher, attorney
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8/2/02
2307-057CIP